



BC847BVN

COMPLEMENTARY PAIR SMALL SIGNAL TRANSISTOR IN SOT563

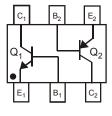
Features

- **Epitaxial Die Construction**
- Two Internally Isolated NPN/PNP Transistors in One Package
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/
- An Automotive-Compliant Part Is Available Under Separate Datasheet (BC847BVNQ)

Mechanical Data

- Surface Mount Package
- Weight: 0.003 grams (Approximate)
- Max Soldering Temperature +260°C for 30 secs as per JEDEC J-STD-020
- Case Material Molded Plastic, UL Flammability Rating 94V-0
- Terminals: Finish Matte Tin Plated Leads, Solderable
- per MIL-STD-202. Method 208 @3

SOT563 Top View



Device Schematic Top View

Ordering Information (Note 4)

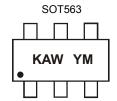
Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
BC847BVN-7	Standard	KAW	7	8	3,000

Bottom View

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



KAW = Product Type Marking Code YM = Date Code Marking Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н		J	K	L	М	N	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings: NPN, BC847B Type (Q_1) (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	50	V
Collector-Emitter Voltage	V_{CEO}	45	V
Emitter-Base Voltage	V_{EBO}	6	V
Collector Current	Ic	100	mA
Peak Pulse Collector Current (single pulse)	I _{CM}	200	mA
Peak Pulse Emitter Current (single pulse)	I _{EM}	200	mA

Maximum Ratings: PNP, BC857B Type (Q₂) (@ T_A = +25°C unless otherwise specified.)

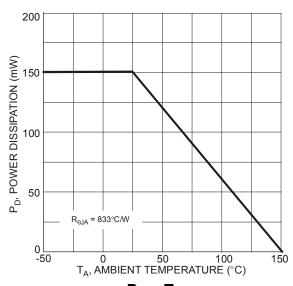
Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-50	V
Collector-Emitter Voltage	V_{CEO}	-45	V
Emitter-Base Voltage	V_{EBO}	-6	V
Collector Current	Ic	-100	mA
Peak Pulse Collector Current (single pulse)	I _{CM}	-200	mA
Peak Pulse Emitter Current (single pulse)	I _{EM}	-200	mA

Thermal Characteristics – Total Device (@ TA = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5) Total Device	P _D	150	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	833	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Note:

Thermal Characteristics - Total Device



P_D v T_A

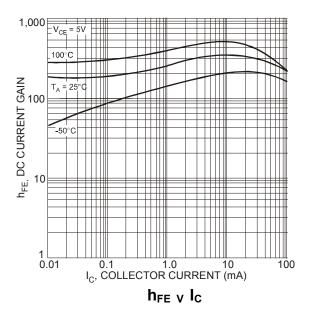
^{5.} For a device surface mounted on minimum recommended pad layout FR-4 PCB with single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

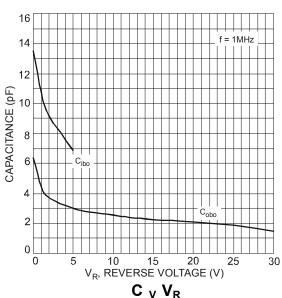


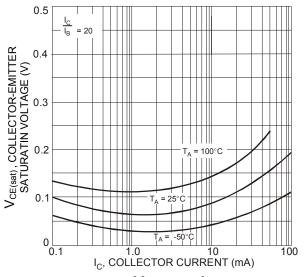
Electrical Characteristics: NPN, BC847B Type (Q₁) (@ T_A = +25°C unless otherwise specified.)

Characteristic (Note 6)	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	50	1	1	V	$I_C = 100 \mu A, I_B = 0$
Collector-Emitter Breakdown Voltage	BV _{CEO}	45	1	1	>	$I_C = 10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	6		_	V	$I_E = 100 \mu A, I_C = 0$
DC Current Gain	h _{FE}	200	290	450	_	$V_{CE} = 5.0V, I_{C} = 2.0mA$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	1	90 200	250 600	l mv	I_C = 10mA, I_B = 0.5mA I_C = 100mA, I_B = 5.0mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	-	700 900	_	mV	$I_C = 10$ mA, $I_B = 0.5$ mA $I_C = 100$ mA, $I_B = 5.0$ mA
Base-Emitter Voltage	V _{BE(on)}	580 —	660 —	700 720	l mv	$V_{CE} = 5.0V, I_{C} = 2.0mA$ $V_{CE} = 5.0V, I_{C} = 10mA$
Collector Cut Off Current	I _{CBO}			15 5.0	_	V _{CB} = 30V V _{CB} = 30V, T _A = +150°C
Transition Frequency	f _T	100	300	_	MHz	V _{CE} = 5.0V, I _C = 10mA, f = 100MHz
Collector-Base Capacitance	C _{cbo}	_	3.5	6.0	pF	V _{CB} = 10V, f = 1.0MHz

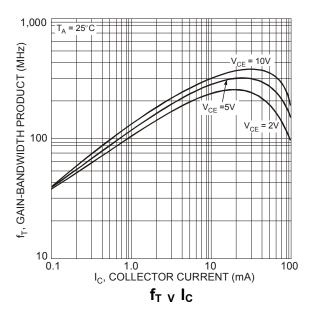
Note: 6. Short duration pulse test used to minimize self-heating effect.









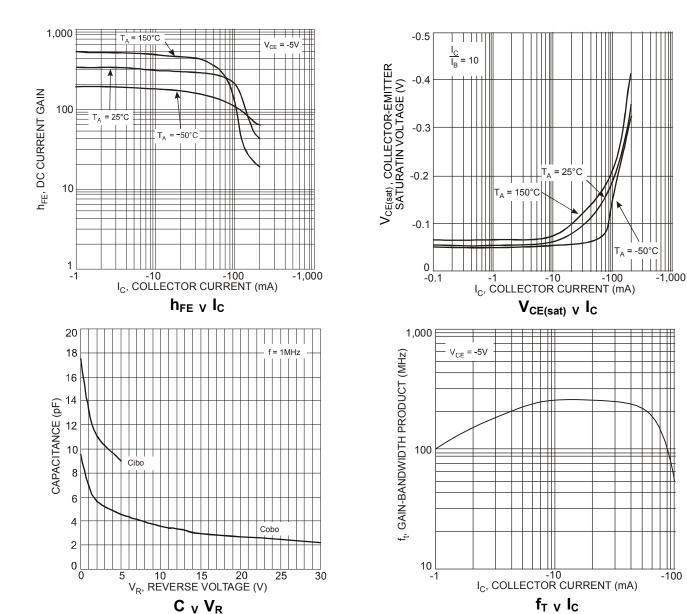




Electrical Characteristics: PNP, BC857B Type (Q₂) (@T_A = +25°C unless otherwise specified.)

Characteristic (Note 7)	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-50	1		V	$I_C = -100\mu A, I_B = 0$
Collector-Emitter Breakdown Voltage	BV _{CEO}	-45	1		V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	6	1		V	$I_E = -100 \mu A, I_C = 0$
DC Current Gain	h _{FE}	220	290	475	_	$V_{CE} = -5.0V, I_{C} = -2.0mA$
Collector-Emitter Saturation Voltage	V _{CE(sat)}	1	-75 -250	-300 -650	mV	$I_C = -10mA$, $I_B = -0.5mA$ $I_C = -100mA$, $I_B = -5.0mA$
Base-Emitter Saturation Voltage	V _{BE(sat)}		-700 -850	— -950	mV	$I_C = -10\text{mA}, I_B = -0.5\text{mA}$ $I_C = -100\text{mA}, I_B = -5.0\text{mA}$
Base-Emitter Voltage	V _{BE(on)}	-600 —	-650 —	-750 -820	mV	V_{CE} = -5.0V, I_{C} = -2.0mA V_{CE} = -5.0V, I_{C} = -10mA
Collector Cut Off Current	I _{CBO}			-15 -4.0	nΑ μΑ	V _{CB} = -30V V _{CB} = -30V, T _A = +150°C
Transition frequency	f _T	100	200	1	MHz	$V_{CE} = -5.0V$, $I_{C} = -10mA$, $f = 100MHz$
Collector-Base Capacitance	C _{cbo}	_	3	4.5	pF	V _{CB} = -10V, f = 1.0MHz

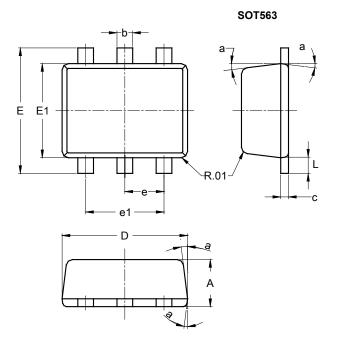
Note: 7. Short duration pulse test used to minimize self-heating effect.





Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

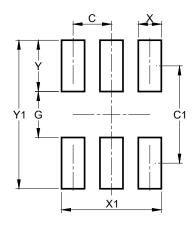


SOT563							
Dim	Min	Max	Тур				
Α	0.55	0.60	0.60				
b	0.15	0.30	0.20				
С	0.10	0.18	0.11				
D	1.50	1.70	1.60				
Е	1.55	1.70	1.60				
E1	1.10	1.25	1.20				
е			0.50				
e1	0.90	1.10	1.00				
L	0.10	0.30	0.20				
а	8°	9°	7°				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT563



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1.940



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